

# **MOSFET** – Power, Dual N-Channel, for 1-Cell Lithium-ion Battery Protection

12 V, 3.2 mΩ, 27 A

# **EFC6611R**

This Power MOSFET features a low on-state resistance. This device is suitable for applications such as power switches of portable machines. Best suited for 1-cell lithium-ion battery applications.

#### **Features**

- 2.5 V Drive
- 2 kV ESD HBM
- Common-Drain Type
- ESD Diode-Protected Gate
- Pb-Free, Halogen Free and RoHS Compliance

# **Applications**

• 1-Cell Lithium-ion Battery Charging and Discharging Switch

### **SPECIFICATIONS**

# ABSOLUTE MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

| Parameter  | Symbol           | Value       | Unit |
|--|------------------|-------------|------|
| Source to Source Voltage   | V <sub>SSS</sub> | 12          | V    |
| Gate to Source Voltage   | $V_{GSS}$        | ±8          | V    |
| Source Current (DC)  | I <sub>S</sub>   | 27          | Α    |
| Source Current (Pulse)<br>PW ≤ 100 μs, Duty Cycle ≤ 1%                                       | I <sub>SP</sub>  | 100         | Α    |
| Total Dissipation<br>Surface mounted on ceramic substrate<br>(5000 mm <sup>2</sup> x 0.8 mm) | P <sub>T</sub>   | 2.5         | W    |
| Junction Temperature   | Tj               | 150         | °C   |
| Storage Temperature  | T <sub>stg</sub> | -55 to +150 | °C   |

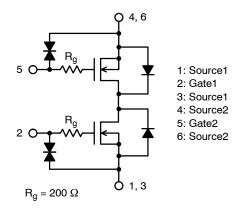
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

# THERMAL RESISTANCE RATINGS

| Parameter  | Symbol        | Value | Unit |
|--|---------------|-------|------|
| Junction to Ambient<br>Surface mounted on ceramic substrate<br>(5000 mm <sup>2</sup> x 0.8 mm) | $R_{	hetaJA}$ | 50    | °C/W |

| V <sub>SSS</sub> | R <sub>SS(on)</sub> MAX I <sub>S MA</sub> |      |
|------------------|---|------|
| 12 V             | $3.2~\mathrm{m}\Omega$ @ $4.5~\mathrm{V}$ | 27 A |
|                  | 3.2 mΩ @ 4.0 V                            |      |
|                  | 3.2 mΩ @ 3.8 V                            |      |
|                  | 4.4 mΩ @ 3.1 V                            |      |
|                  | 6.3 mΩ @ 2.5 V                            |      |

# ELECTRICAL CONNECTION N-Channel





# CSP6, 1.77x3.54/ EFCP3517-6DGH-020 CASE 568AL

# MARKING DIAGRAM

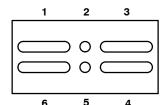
ML YMZZ

ML = Device CodeY = Year of Production

M = Month of Assembly Operation

ZZ = Assembly Lot Number

### **PIN CONNECTIONS**



# ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

# **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C)

| Parameter                                      | Symbol                            | Test Condition   | Min | Тур    | Max | Unit |
|--|-----------------------------------|--|-----|--------|-----|------|
| Source to Source Breakdown Voltage             | V( <sub>BR</sub> ) <sub>SSS</sub> | I <sub>S</sub> = 1 mA, V <sub>GS</sub> = 0 V (Test Circuit 1)        | 12  | -      | -   | V    |
| Zero-Gate Voltage Source Current               | I <sub>SSS</sub>                  | V <sub>SS</sub> = 10 V, V <sub>GS</sub> = 0 V (Test Circuit 1)       | -   | -      | 1   | μΑ   |
| Gate to Source Leakage Current                 | I <sub>GSS</sub>                  | V <sub>GS</sub> = ±8 V, V <sub>SS</sub> = 0 V (Test Circuit 2)       | -   | -      | ±1  | μΑ   |
| Gate Threshold Voltage                         | V <sub>GS</sub> (th)              | V <sub>SS</sub> = 6 V, I <sub>S</sub> = 1 mA (Test Circuit 3)        | 0.5 | -      | 1.3 | V    |
| Forward Transconductance                       | 9 <sub>FS</sub>                   | V <sub>SS</sub> = 6 V, I <sub>S</sub> = 3 A (Test Circuit 4)         | -   | 19     | -   | S    |
| Static Source to Source On-State<br>Resistance | R <sub>SS(on)</sub> 1             | I <sub>S</sub> = 5 A, V <sub>GS</sub> = 4.5 V (Test Circuit 5)       | 1.8 | 2.3    | 3.2 | mΩ   |
|  | R <sub>SS(on)</sub> 2             | I <sub>S</sub> = 5 A, V <sub>GS</sub> = 4.0 V (Test Circuit 5)       | 1.9 | 2.4    | 3.2 | mΩ   |
|  | R <sub>SS(on)</sub> 3             | I <sub>S</sub> = 5 A, V <sub>GS</sub> = 3.8 V (Test Circuit 5)       | 2.0 | 2.6    | 3.2 | mΩ   |
|  | R <sub>SS(on)</sub> 4             | I <sub>S</sub> = 5 A, V <sub>GS</sub> = 3.1 V (Test Circuit 5)       | 2.1 | 3.3    | 4.4 | mΩ   |
|  | R <sub>SS(on)</sub> 5             | I <sub>S</sub> = 5 A, V <sub>GS</sub> = 2.5 V (Test Circuit 5)       | 2.7 | 4.0    | 6.3 | mΩ   |
| Turn-ON Delay Time                             | t <sub>d(on)</sub>                | V <sub>SS</sub> = 6 V, V <sub>GS</sub> = 4.5 V, I <sub>S</sub> = 3 A | -   | 80     | -   | ns   |
| Rise Time                                      | t <sub>r</sub>                    | - (Test Circuit 6)   | -   | 570    | =   | ns   |
| Turn-OFF Delay Time                            | t <sub>d(off)</sub>               | 1  | -   | 38,000 | =   | ns   |
| Fall Time                                      | t <sub>f</sub>                    | 1  | -   | 17,700 | =   | ns   |
| Total Gate Charge                              | Qg                                | $V_{SS}$ = 6 V, $V_{GS}$ = 4.5 V, $I_{S}$ = 27 A (Test Circuit 7)    | -   | 100    | -   | nC   |
| Forward Source to Source Voltage               | $V_{F(S-S)}$                      | I <sub>S</sub> = 3 A, V <sub>GS</sub> = 0 V (Test Circuit 8)         | _   | 0.75   | 1.2 | V    |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

# **ORDERING INFORMATION**

| Device      | Marking | Package  | Shipping (Qty / Packing) <sup>†</sup> |
|-------------|---------|--|---------------------------------------|
| EFC6611R-TF | ML      | CSP6, 1.77 × 3.54<br>EFCP3517-6DGH-020<br>(Pb–Free / Halogen Free) | 5,000 / Tape & Reel                   |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# TEST CIRCUITS ARE EXAMPLE OF MEASURING FET1 SIDE

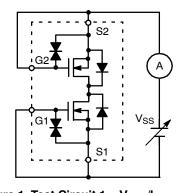
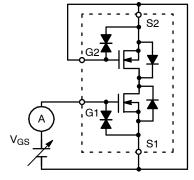


Figure 1. Test Circuit 1 –  $V_{SSS}/I_{SSS}$ 



When FET1 is measured, Gate and Source of FET2 are short-circuited.

Figure 2. Test Circuit 2 - I<sub>GSS</sub>

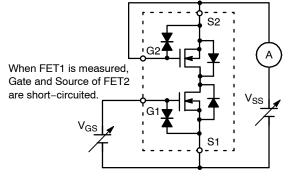
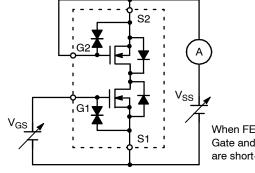


Figure 3. Test Circuit 3 - V<sub>GS</sub>(th)



When FET1 is measured, Gate and Source of FET2 are short-circuited.

Figure 4. Test Circuit 4 - g<sub>FS</sub>

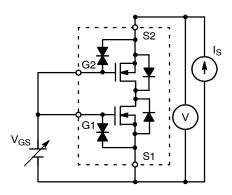


Figure 5. Test Circuit 5 - R<sub>SS(on)</sub>

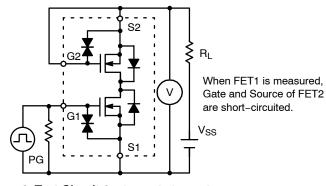


Figure 6. Test Circuit 6 –  $t_{d(on)}$ ,  $t_r$ ,  $t_{d(off)}$ ,  $t_f$ 

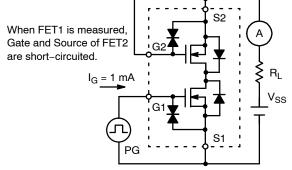


Figure 7. Test Circuit 7 - Qq

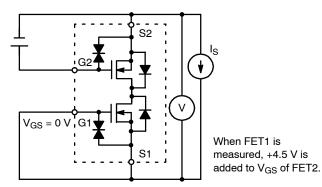
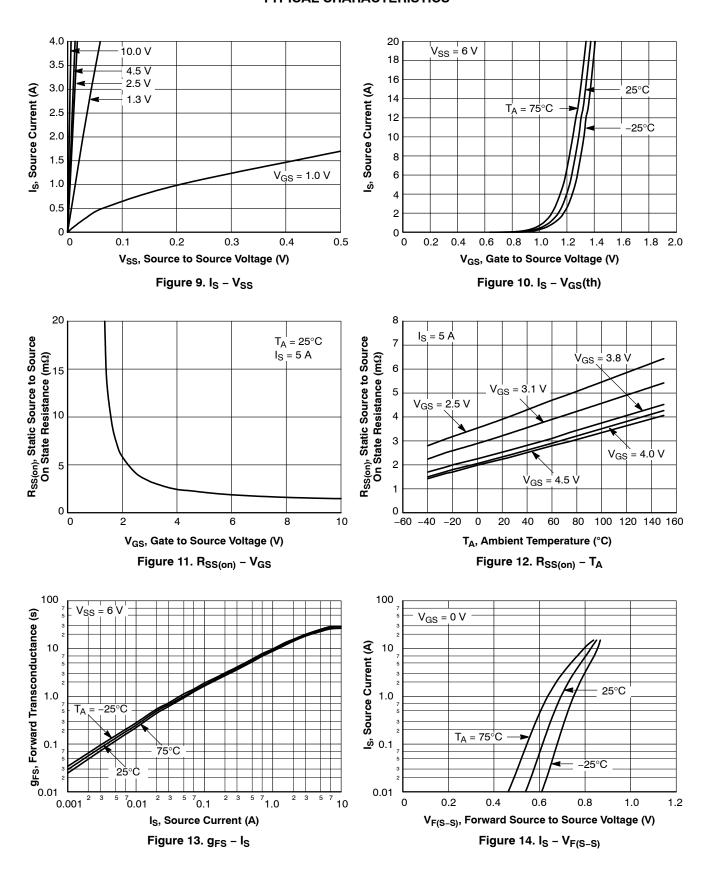


Figure 8. Test Circuit 8 - V<sub>F(S-S)</sub>

NOTE: When FET2 is measured, the position of FET1 and FET2 is switched.

# **TYPICAL CHARACTERISTICS**



# TYPICAL CHARACTERISTICS (Continued)

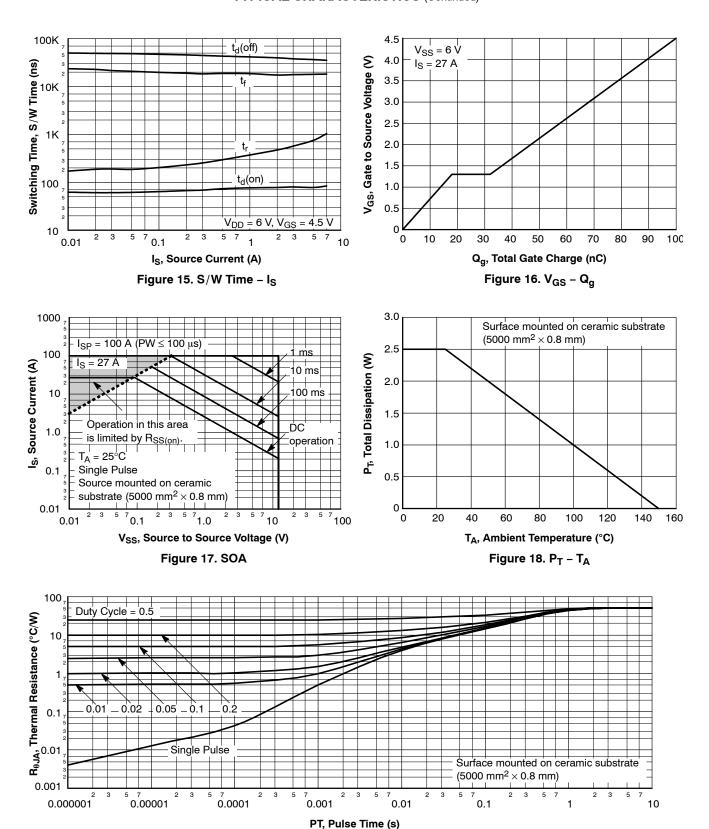


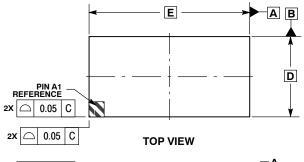
Figure 19.  $R_{\theta JA}$  – Pulse Time



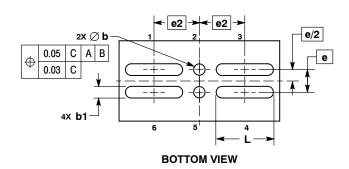


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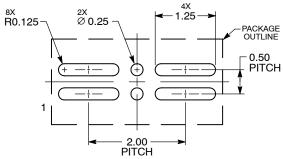


#### NOTES:

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS.

|     | MILLIMETERS |      |  |
|-----|-------------|------|--|
| DIM | MIN MAX     |      |  |
| Α   |             | 0.22 |  |
| b   | 0.22        | 0.28 |  |
| b1  | 0.22        | 0.28 |  |
| D   | 1.77 BSC    |      |  |
| E   | 3.54 BSC    |      |  |
| е   | 0.50 BSC    |      |  |
| e2  | 1.00 BSC    |      |  |
| L   | 1.22        | 1.28 |  |

# RECOMMENDED SOLDERING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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